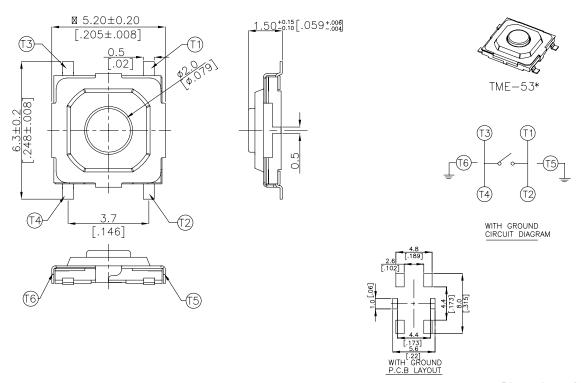


## RoHS Compliant

## **Specification**

General Tolerances : ±0.2mm

## Diagram



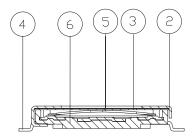
Dimensions: Millimetres (Inches)

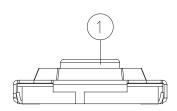
Item	Description	Q'ty	Materials	Treatment
1	Stem		SPCF-SD	NI Plating 1.5~5um
2	Cover		□ =Nickel Silver S = Stainless Steel	□=None S = With Silver Plating
3	Adhesive Tape	1	Teflon	None
4	Terminal		Phosphor Bronze	With Silver Plating
5	Contact		Stainless Steel	With Silver Cladding
6	Base		High – Temp Thermoplastic LCP	Molded Black

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# multicomp PRO





#### 1. Style

This specification describes"TACTILE SWITCH", mainly used as signal switch of electric devices, with the general requirements of mechanical and electrical characteristic.

1.1 Operating Temperature Range : -25°C to +70°C 1.2 Storage Temperature Range : -30°C to +80°C

2. Current Range: 50mA, 12V DC3. Type of Actuation: Tactile feedback

4. Test Sequence:

Item	Description	Test Conditions	Requirements		
Appearance					
1	Visual Examination	By Visual Examination choke without any out pressure & testing	There shall be no defects that affect the serviceability of the product.		
Electr	ric Performanc	e			
2	Contact Resistance	Applying a static load 1.5 to 2 times the operating force to the center of the stem , measurements shall be made with a 1 kHz small current contact resistance meter	100mΩ Max.(Initial)		
3	Insulation Resistance	Measurements shall be made following application of 500 V DC potential across terminals and cover for 1 minute ± 5 seconds	100MΩ Min.		
4	Dielectric Withstanding Voltage	250 V AC(50Hz or 60Hz) shall be applied across terminals and cover for 1 minute	There shall be no breakdown or flashover		
5	Bounce	3 to 4 operations at a rate of 1 cycles per second  Switch  Synchroscope  5V DC 5ΚΩ	5 m seconds Max.		



Mech	anical Perfprm	ance					
		Applied in the direction of operation.					
6	Operation Force	OF CONTRACTOR OF	70±50g	100±50g	160±50g	260±50g	350±50g
7	Stroke	Placing the switch such that the direction of switch operation is vertical and then gradually increasing the load applied to the stem, the stroke distance for the stem to come to a stop shall be measured	0.25+0.1/-0.2mm				
8	Stop Strength	Placing the switch such that the direction of switch operation is vertical, a static load of 3 kgf(29.4N) shall be applied in the direction of stem operation for a period of 15 seconds	1) As shown in item 4~7 2) Contact Resistance: 200 mΩ Max. 3) Insulation Resistance: 10 MΩ Min				
9	Solder Heat Resistance	1.PCB is 1.6mm in thickness 2.SMT Type ~MPTMG(E), TJG(E)-5 Series(4/4)	1 )As shown in item 4, 5 2) Contact Resistance: 200mΩ Max 3) Insulation Resistance: 10MΩ min				
10	Vibration	Shall be vibrated in accordance with Method 201A of MIL-STD-202F  1) Frequency: 10-55-10 Hz in 1 minute/Cycle 2) Direction: 3 vertical directions including the direction of operation. 3) Test Time: 2 hours each direction.	1) As shown in item 4~7 2) Contact Resistance: 200mΩ Max 3) Insulation Resistance: 10MΩ min				
Mech	anical Perform						
11	Shock	Shall be shocked in accordance with Method 213B condition A of MIL-STD-202F  1. Acceleration; 50G  2. Action time:11±1m seconds  3. Testing Direction: 6 sides  4. Test Cycle: 3 times in each direction	Ditto				
Durak	oility			1			
12	Operating Life	Measurements shall be made following the test forth below:  1. 5 mA, 5 VDC resistive load  2. Applying a static load the operating force to the center of the stem in the direction of operation Static Load = OF max 2 cycles/sec  3. Cycle of Operation: 1,000,000 cycles min. for 100, 160gf 200,000 cycles min. for 260, 350gf	1. As shown in item 4, 5 2. Operating force:±50% of initial force . 3. Contact Resistance: 10Ω Max 4. Insulation Resistance: 10MΩ min 5. Bounce: 10 m seconds Max		ce .		
Weath	ner-Proof						
13	Resistance Low Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for 1 hour before the measurements are made: 1.Temperature:-25±3°C 2.Time: 96 hours	2) Conta		ance: 200	OmΩ Max OMΩ min	

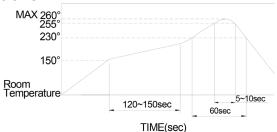
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14	Resistance High Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for 1 hour before the measurements are made: 1.Temperature:80±2°C 2.Time: 96 hours	Ditto
15	Humidity Resistance	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for 1 hour before the measurements are made: 1) Temperature: 40°C±2°C 2) Relative Humidity:90~95% 3) Time: 96 hour	Ditto

### **Soldering Conditions**



- The condition mentioned above is the temperature on the Cu foil of the PCB surface. There are cases where board's temperature greatly differs fromswitch's surface be used not to allow switch's surface temperature to exceed 260°C.
- · Manual Soldering

Soldering Temperature : Max.350°C
Continuous Soldering Time : Max. 5 seconds

#### **Part Number Table**

Description	Part Number
Tactile Switch, 5.2mm × 5.2mm, SMT, G Pin, H1.5mm. 160g	MPTME-533-Q-T/R
Tactile Switch, 5.2mm × 5.2mm, SMT, G Pin, H1.5mm, 260g	MPTME-534-Q-T/R
Tactile Switch, 5.2mm × 5.2mm, SMT, G Pin, H2mm, 160g	MPTME-543-Q-T/R

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